

Title (en)

SUBSTRATE FOR AN ELECTRONIC OR ELECTROMECHANICAL COMPONENT AND NANO-ELEMENTS

Title (de)

SUBSTRAT FÜR EINE ELEKTRONISCHE ODER ELEKTROMECHANISCHE KOMPONENTE UND NANOELEMENTE

Title (fr)

SUBSTRAT POUR COMPOSANT ÉLECTRONIQUE OU ÉLECTROMÉCANIQUE ET NANOELEMENTS

Publication

**EP 2319076 A1 20110511 (FR)**

Application

**EP 09782394 A 20090831**

Priority

- EP 2009061203 W 20090831
- FR 0855852 A 20080901

Abstract (en)

[origin: WO2010023308A1] The invention relates to a substrate for carrying at least one electronic or electromechanical component (708) and one or more nano-elements that comprises a base carrier (301), a catalytic system (302), a barrier layer (303) and a layer (304) capable of receiving the electronic or electromechanical component and made of monocrystalline Si or Ge or a mixture of these materials. The catalytic system (302) bears on the base carrier (301) without contacting the layer (304) capable of receiving the electronic or electromechanical component, and the barrier layer (303) is sandwiched between the catalytic system (302) and the layer (304) capable of receiving the electronic or electromechanical component. The barrier layer (303) does not contact the base carrier (301).

IPC 8 full level

**H01L 21/768** (2006.01); **H01L 23/522** (2006.01); **H01L 23/532** (2006.01); **H01L 29/06** (2006.01)

CPC (source: EP KR US)

**B81C 1/00349** (2013.01 - EP US); **B82Y 10/00** (2013.01 - EP US); **F02D 13/02** (2013.01 - EP US); **H01L 21/187** (2013.01 - EP US);  
**H01L 21/768** (2013.01 - KR); **H01L 21/76879** (2013.01 - EP US); **H01L 21/76898** (2013.01 - EP US); **H01L 23/481** (2013.01 - EP US);  
**H01L 23/522** (2013.01 - KR); **H01L 23/53276** (2013.01 - EP US); **H01L 29/0673** (2013.01 - EP US); **H01L 29/0676** (2013.01 - EP US);  
**H01L 25/0657** (2013.01 - EP US); **H01L 29/0665** (2013.01 - EP US); **H01L 2221/1094** (2013.01 - EP US); **H01L 2924/0002** (2013.01 - EP US);  
**H10K 71/164** (2023.02 - EP US); **H10K 85/20** (2023.02 - EP US); **Y02T 10/12** (2013.01 - EP US)

Citation (search report)

See references of WO 2010023308A1

Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

Designated extension state (EPC)

AL BA RS

DOCDB simple family (publication)

**WO 2010023308 A1 20100304**; EP 2319076 A1 20110511; FR 2935538 A1 20100305; FR 2935538 B1 20101224; JP 2012501531 A 20120119;  
KR 20110046536 A 20110504; US 2011233732 A1 20110929

DOCDB simple family (application)

**EP 2009061203 W 20090831**; EP 09782394 A 20090831; FR 0855852 A 20080901; JP 2011524407 A 20090831; KR 20117006141 A 20090831;  
US 200913059651 A 20090831